

J606-VB Datasheet

P-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^c			
- 60	0.0074 at V _{GS} = - 10 V	- 90			
	0.0094 at V _{GS} = - 4.5 V	- 90			

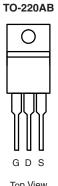
FEATURES

- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

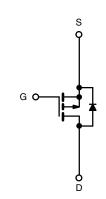
• DC/DC Primary Switch





Drain connected to Tab

Top View



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 60	v		
Gate-Source Voltage	V _{GS}	± 20	v		
Continuous Durin Quarter (T. 175 90)6	T _C = 25 °C	L	- 90		
Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^{c}$	T _C = 125 °C	I _D	- 67	A	
Pulsed Drain Current		I _{DM}	- 200	A	
Avalanche Current	L = 0.1 mH	I _{AS}	- 65		
Single Pulse Avalanche Energy ^a		E _{AS}	211	mJ	
Power Dissipation	T _C = 25 °C	P _D	250 ^b	w	
	T _A = 25 °C		2.4	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Symbol	Limit	Unit			
R _{thJA}	62	°C/W			
R _{thJC}	0.6				
	R _{thJA}	R _{thJA} 62			

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. Limited by package.



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · · · ·					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA - 60				Ň	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	50 μA	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 175 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			А	
		V _{GS} = - 10 V, I _D = - 30 A		0.0074			
	Р	V_{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.0150		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.0190			
		V _{GS} = - 4.5 V, I _D = - 20 A		0.0094			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 30 A	20			S	
Dynamic ^b		••					
Input Capacitance	C _{iss}			9200		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = -25 V$, f = 1 MHz		975			
Reverse Transfer Capacitance	C _{rss}			760			
Total Gate Charge ^c	Qg			160	240	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -90$ A		40			
Gate-Drain Charge ^c	Q _{gd}			36			
Gate Resistance	R _g	f = 1.0 MHz		3		Ω	
Turn-On Delay Time ^c	t _{d(on)}			20	30		
Rise Time ^c	t _r	V_{DD} = - 30 V, R_L = 0.33 Ω		190	285	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ - 90 A, V_GEN = - 10 V, R_g = 2.5 Ω		140	210		
Fall Time ^c	t _f			300	450	1	
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b					
Continuous Current	۱ _S				- 90	۸	
Pulsed Current	I _{SM}				- 200	A	
Forward Voltage ^a	V _{SD}	I _F = - 50 A, V _{GS} = 0 V		- 1.0	- 1.5	V	
Reverse Recovery Time	t _{rr}			60	90	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 50 A, dl/dt = 100 A/μs		- 3	- 4.5	А	
Reverse Recovery Charge	Q _{rr}	1		0.09	0.2	μC	

Notes:

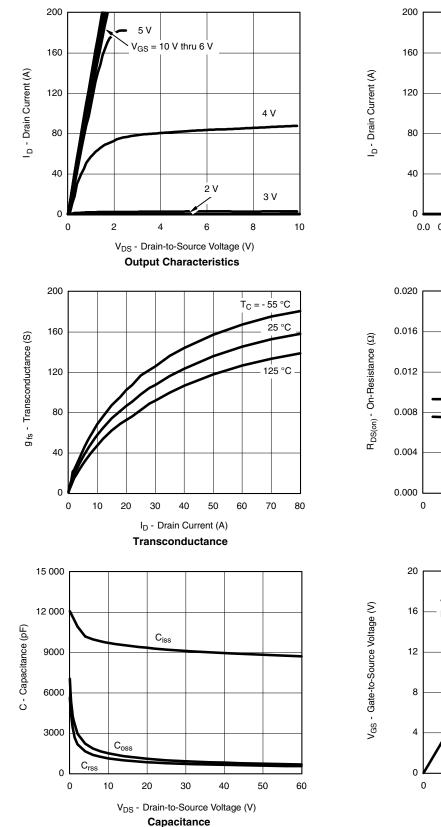
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

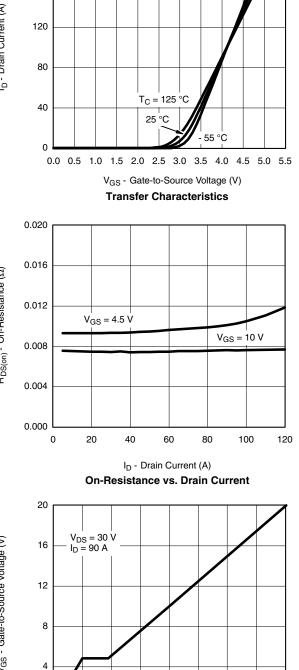
c. Independent of operating temperature.

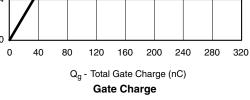
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





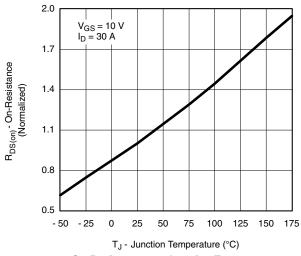
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



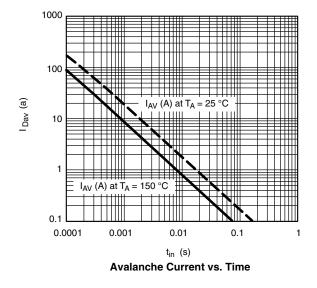


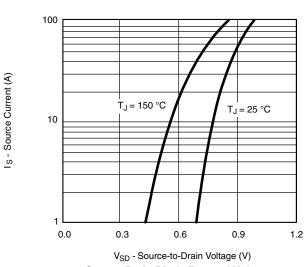


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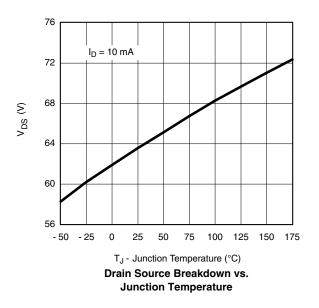


On-Resistance vs. Junction Temperature



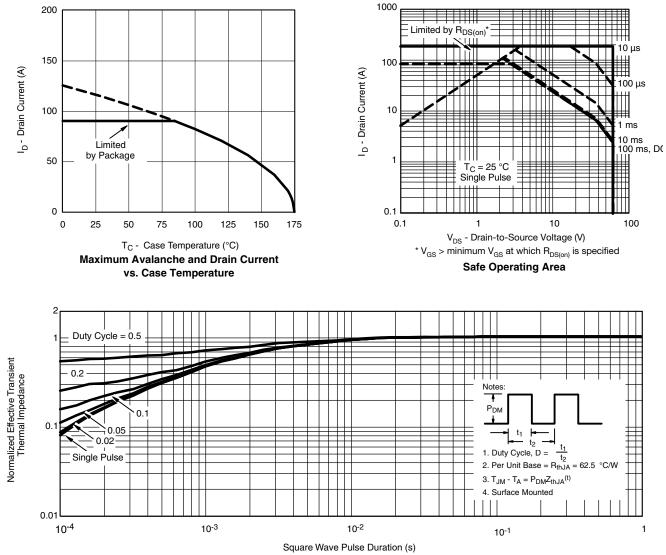


Source-Drain Diode Forward Voltage





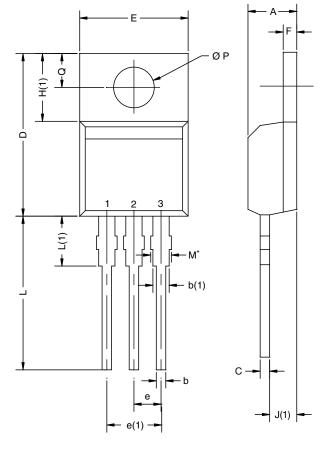
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



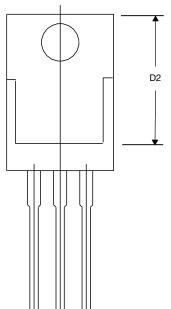
TO-220AB



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14- DWG: 547	0413-Rev. P, 1	16-Jun-14		•	

Note

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM





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